COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>PCB VIEWED FROM TOP SIDE</th>
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<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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PLOT NAME = Top Assembly Drawing
GENERATED : 5/15/2014 7:08:49 AM  TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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